





30V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

| V _{(BR)DSS} | R _{DS(on) max} | I _D T _A = +25°C |
|----------------------|--------------------------------|--|
| 30V | $29m\Omega$ @ V_{GS} = $10V$ | 5.6A |
| 30 V | $35m\Omega$ @ $V_{GS} = 4.5V$ | 4.8A |

Description

This new generation MOSFET has been designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- DC Motor Control
- DC-AC Inverters

Features and Benefits

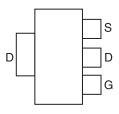
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

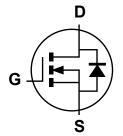
- Case: SOT223
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0 (Note 1)
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See diagram below
- Terminals: Finish Matte Tin annealed over Copper lead frame.
 Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.112 grams (approximate)







Pin Out - Top View



Equivalent Circuit

Ordering Information (Note 4)

| Part Number | Qualification | Case | Packaging |
|--------------|---------------|--------|---------------------|
| DMN3032LE-13 | Standard | SOT223 | 2,500 / Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information





Oll = Manufacturer's Marking
N3032L = Marking Code
YWW = Date Code Marking for SAT (Shanghai Assembly/ Test site)
WW = Date Code Marking for CAT (Chengdu Assembly/ Test site)
Y or Y= Year (ex: 3 = 2013)
WW = Week (01 - 53)



| Characteristic | Symbol | Value | Units | |
|---|--|------------------|--------------|---|
| Drain-Source Voltage | | V _{DSS} | 30 | V |
| Gate-Source Voltage | V _{GSS} | ±20 | V | |
| Continuous Drain Current (Note 5) // = 10// | T _A = +25°C T _A = +70°C | I _D | 5.6 4.1 | А |
| Continuous Drain Current (Note 5) V _{GS} = 10V | T _C = +25°C T _C = +70°C | I _D | 15.4 12.1 | А |
| Maximum Continuous Body Diode Forward Current (Note 5) | I _S | 1.5 | Α | |
| Pulsed Drain Current (10µs pulse, duty cycle = 1%) | I _{DM} | 25 | A | |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Units | |
|--|------------|-----------------------------------|-------------|------|
| Total Power Dissipation (Note 5) | Ta = +25°C | P _D | 1.8 | W |
| Total Fower Dissipation (Note 3) | Ta = +70°C | | 1.1 | |
| Thermal Resistance, Junction to Ambient (Note 5) | | $R_{	heta JA}$ | 69 | °C/W |
| Total Power Dissipation (Note 5) | | P _D | 14 | W |
| Thermal Resistance, Junction to Case (Note 5) | | $R_{	heta JC}$ | 8.7 | °C/W |
| Operating and Storage Temperature Range | | T _J , T _{STG} | -55 to +150 | °C |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|-------------------------------------|----------------------|-----|------|------|-------|---|
| OFF CHARACTERISTICS (Note 6) | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 30 | _ | _ | V | V _{GS} = 0V, I _D = 250μA |
| Zero Gate Voltage Drain Current | I _{DSS} | _ | _ | 1 | μA | V _{DS} = 30V, V _{GS} = 0V |
| Gate-Source Leakage | I _{GSS} | _ | _ | ±100 | nA | V_{GS} = ±20V, V_{DS} = 0V |
| ON CHARACTERISTICS (Note 6) | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | 1 | _ | 2 | V | $V_{DS} = V_{GS}$, $I_D = 250\mu A$ |
| Static Drain-Source On-Resistance | D | _ | 22 | 29 | mΩ | V _{GS} = 10V, I _D = 3.2A |
| Static Dialii-Source Oil-Resistance | R _{DS (ON)} | _ | 27 | 35 | 11122 | V _{GS} = 4.5V, I _D = 2.8A |
| Forward Transfer Admittance | Y _{fs} | _ | 7 | _ | S | V _{DS} = 5V, I _D = 5.8A |
| Diode Forward Voltage | V_{SD} | _ | 0.7 | 1.5 | V | V _{GS} = 0V, I _S = 1A |
| DYNAMIC CHARACTERISTICS (Note 7) | | | | | | |
| Input Capacitance | C _{iss} | _ | 498 | _ | | V _{DS} = 15V, V _{GS} = 0V f = 1MHz |
| Output Capacitance | Coss | _ | 52 | _ | pF | |
| Reverse Transfer Capacitance | C _{rss} | _ | 45 | _ | | |
| Gate Resistnace | R_g | _ | 2.2 | _ | Ω | $V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$ |
| Total Gate Charge | Q_g | _ | 11.3 | _ | | $V_{DS} = 15V$, $V_{GS} = 10V$, $I_{D} = 5.8A$ |
| Gate-Source Charge | Q_{gs} | _ | 1.4 | _ | nC | |
| Gate-Drain Charge | Q_{gd} | _ | 2.1 | _ | | |
| Turn-On Delay Time | t _{D(on)} | _ | 2.3 | _ | | V _{DS} = 15V, V _{GS} = 10V, |
| Turn-On Rise Time | t _r | _ | 3.9 | _ | no | |
| Turn-Off Delay Time | t _{D(off)} | _ | 10 | _ | ns | $R_L = 2.6\Omega, R_G = 3\Omega$ |
| Turn-Off Fall Time | t _f | | 1.9 | | | |

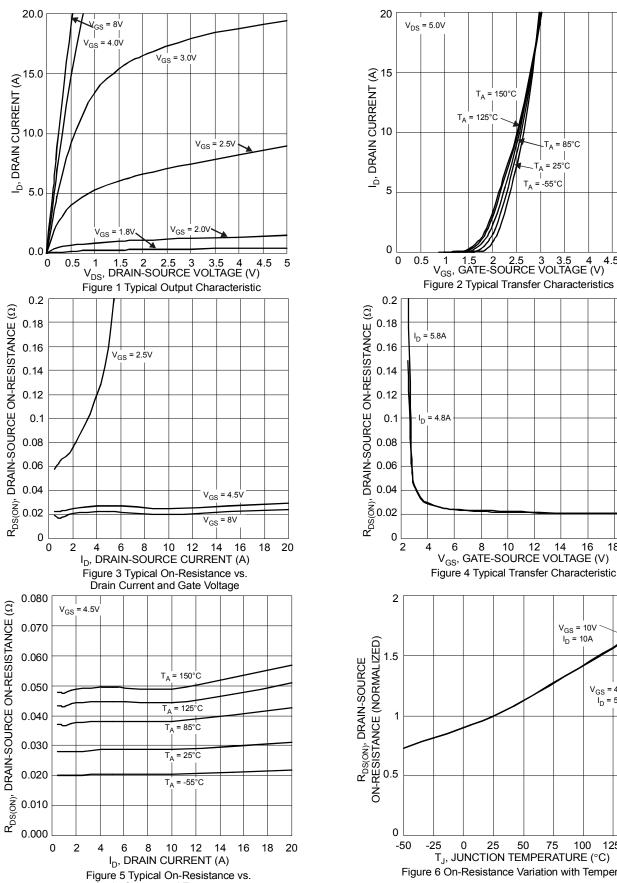
5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1inch square copper plate 6 .Short duration pulse test used to minimize self-heating effect. Notes:

^{7.} Guaranteed by design. Not subject to production testing.

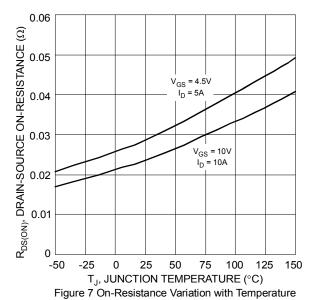
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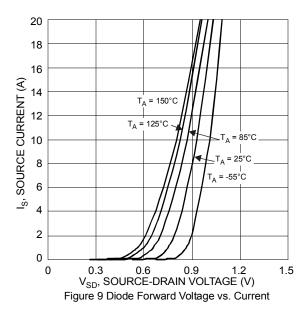
T_A = 25°C T_A = -55°C

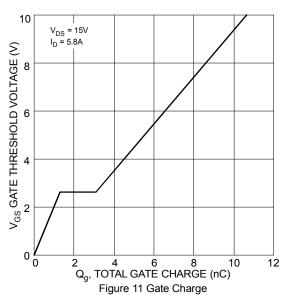












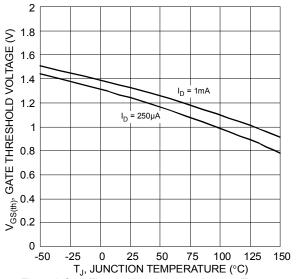
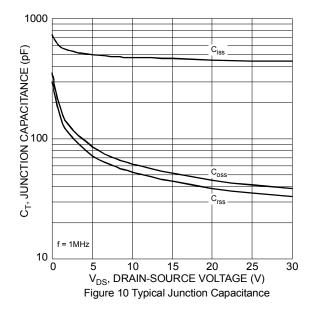
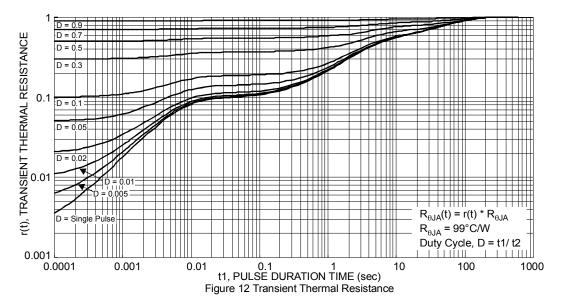


Figure 8 Gate Threshold Variation vs. Ambient Temperature

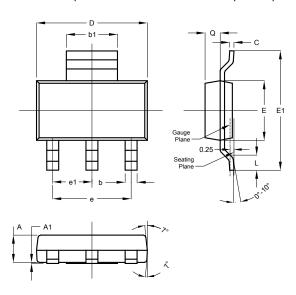






Package Outline Dimensions

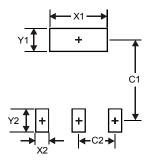
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



| SOT223 | | | | | | |
|----------------------|-------|------|------|--|--|--|
| Dim | Min | Max | Тур | | | |
| Α | 1.55 | 1.65 | 1.60 | | | |
| A1 | 0.010 | 0.15 | 0.05 | | | |
| b | 0.60 | 0.80 | 0.70 | | | |
| b1 | 2.90 | 3.10 | 3.00 | | | |
| С | 0.20 | 0.30 | 0.25 | | | |
| D | 6.45 | 6.55 | 6.50 | | | |
| Е | 3.45 | 3.55 | 3.50 | | | |
| E1 | 6.90 | 7.10 | 7.00 | | | |
| е | - | - | 4.60 | | | |
| e1 | - | - | 2.30 | | | |
| L | 0.85 | 1.05 | 0.95 | | | |
| Q | 0.84 | 0.94 | 0.89 | | | |
| All Dimensions in mm | | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| X1 | 3.3 |
| X2 | 1.2 |
| Y1 | 1.6 |
| Y2 | 1.6 |
| C1 | 6.4 |
| C2 | 2.3 |



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